L	Hits	Search		Time stamp
Number			USPAT;	2003/02/15
1	2	"5408053" .pn.	US-PGPUB; EPO; JPO;	15:55
2		transmission with different with dielectric	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2003/02/15 15:56
3	0	diferent with dielectric with constant same substrate	DERWENT; IBM_TDB USPAT; US-PGPUB;	2003/02/15 15:56
4	673	dielectric with constant same substrate	EPO; JPO; DERWENT; IBM_TDB USPAT;	2003/02/15
1	3,3	with transmission	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	15:58
5	673	dielectric with constant same substrate with transmission	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/02/15
6	469	dielectric with constant same substrate with transmission	IBM_TDB USPAT	2003/02/15 16:01
7	22	dielectric with different with constant same substrate with transmission	USPAT	2003/02/15 16:01
54	1758	174/262	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/02/15 17:55
55	809	174/263	IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2003/02/15 17:55
56	669	174/264	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/02/15 17:55
57	651	257/759	IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2003/02/15 17:57
58	409	257/798	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2003/02/15 17:57
59	9	257/798 and transmission with lines	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2003/02/15 17:57
60	160	(174/262 174/263 174/264 257/759) and transmission with lines	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2003/02/15 17:58
_	2	6392164.pn-	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2003/02/13
			DERWENT; IBM TDB	

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-	7	("50399" "5408053" "5450290" "5459365" "5473120" "5734560"	PAT	2003/02/11 14:26
-	3	"5835357").PN. ("5120384" "5245136" "5262595").PN.	USPAT	2003/02/11
-	2094	(257/758).CCLS.	USPAT; US-PGPUB;	2003/02/11 15:13
			EPO; JPO; DERWENT; IBM TDB	
-	378	((257/758).CCLS.) and (radius diameter)	USPAT; US-PGPUB; EPO; JPO;	2003/02/11 15:14
			DERWENT; IBM_TDB	2002/02/11
-	280	((257/758).CCLS.) and (radius diameter)	USPAT	2003/02/11 15:23 2003/02/11
-	9	("5386339" "5402003" "5521332" "5798563" "5880925" "6222262" "6292351" "6353189" "6370010").PN.	USPAT	15:15
-	4	("5195053" "5219639" "5512514" "5869901").PN.	USPAT	2003/02/11 15:18
-	0	1993JP-0206678.ap,prai.	USPAT; US-PGPUB; EPO; JPO;	2003/02/11 15:24
-	2	JP-05206678-\$.did.	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2003/02/11
			DERWENT; IBM_TDB	0000 (00 (11
-	1	1993-291906.NRAN.	DERWENT	2003/02/11
-	473	(MULTILAYER or INTERCONNECTION with BOARD)same (ratio diameter radius) and 257/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/11 16:11
-	70	((MULTILAYER or INTERCONNECTION) with BOARD)same (ratio diameter radius) and 257/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/11 15:33
-	1285	((MULTILAYER or INTERCONNECTION) with BOARD)same (ratio diameter radius)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/11 15:33
-	630	((MULTILAYER or INTERCONNECTION) with BOARD)same (ratio diameter radius)	USPAT	2003/02/11 15:36
-	1677	((MULTILAYER or INTERCONNECTION) with BOARD) and (ratio diameter radius) with (through adj holes holes or vias)	USPAT	2003/02/11 15:55
_	11	("2869040" "4295184" "4663840" "4851614" "4970624" "5189261" "5191174" "5280414" "5359767"	USPAT	2003/02/11 15:46
-	8	"5363280" "5414223").PN. 5736679.URPN.	USPAT	2003/02/11 15:46
-	1289	(((MULTILAYER or INTERCONNECTION) with BOARD) and (ratio diameter radius) with (through adj holes holes or vias)) not	USPAT	2003/02/11 16:00
-	924	(((MULTILAYER or INTERCONNECTION) with BOARD)same (ratio diameter radius)) ((((MULTILAYER or INTERCONNECTION) with BOARD)and (ratio diameter radius)with (through adj holes holes or vias)) not (((MULTILAYER or INTERCONNECTION) with BOARD)same (ratio diameter radius))) and	USPAT	2003/02/11 16:01
		(insulating dielectric)		

<u>-</u>	781	(((MUL) YER or INTERCONNECTION) with	U	2003/02/11
	-	BOARD) and (ratio diameter radius) with		16:09
		(through adi holes holes or vias)) not		
	1	(((MULTILAYER or INTERCONNECTION) with		
		BOARD) same (ratio diameter radius))) and		
		(ground power)		
_	9	("3739469" "4494083" "4498122"	USPAT	2003/02/11
	-	"4543715" "5381306" "5623160"		16:03
		"5825084" "6137064" "6181551").PN.	1	
_	34	4494083.URPN.	USPAT	2003/02/11
				16:07
	3	5644276.URPN.	USPAT	2003/02/11
ĺ				16:09
1_	14786	impedance same (diameter or radius ratio)	USPAT	2003/02/11
	i	and (ground power)		16:11
-	0	(MULTILAYER or INTERCONNECTION with	USPAT;	2003/02/11
		BOARD) and 25.	US-PGPUB;	16:11
	}		EPO; JPO;	
			DERWENT;	1
			IBM_TDB	2002/02/11
_	2717	(impedance same (diameter or radius	USPAT;	2003/02/11 16:12
1		ratio) and (ground power)) and (board	US-PGPUB;	10.14
		PCB)	EPO; JPO; DERWENT;	
			IBM TDB	
			USPAT;	2003/02/11
-	177	((impedance same (diameter or radius	US-PGPUB;	16:20
		ratio) and (ground power)) and (board	EPO; JPO;	10.20
		PCB)) and multilayer	DERWENT;	
			IBM TDB	
		(174/262.000).CCLS.	USPAT;	2003/02/11
-	0	(1/4/262.000).ccbs.	US-PGPUB;	16:20
			EPO; JPO;	
1			DERWENT;	İ
			IBM TDB	
	974	(174/262).CCLS.	USPAT;	2003/02/11
-	1 2/4	(174/202):0010:	US-PGPUB;	16:21
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	442	((174/262).CCLS.) and (ground power)	USPAT;	2003/02/11
			US-PGPUB;	16:23
			EPO; JPO;	
			DERWENT;	
1			IBM_TDB	2003/02/13
-	541	(439/876).CCLS.	USPAT; US-PGPUB;	17:39
			EPO; JPO;	1,.35
1	1		DERWENT;	
			IBM TDB	!
	3500	transmission with lines same substrate	USPAT;	2003/02/13
-	3508	and impedance	US-PGPUB;	15:07
		and impedance	EPO; JPO;]
	1		DERWENT;	
			IBM TDB	
	0	(transmission with lines same substrate	USPAT;	2003/02/13
-	"	and impedance) and 174.ccls.	US-PGPUB;	15:03
		and ampound of and	EPO; JPO;	
			DERWENT;	
	1		IBM_TDB	
_	0	174.ccls.	USPAT;	2003/02/13
	Ĭ		US-PGPUB;	15:04
1			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	1	("0000174").PN.	USPAT;	2003/02/13
			US-PGPUB;	15:05
			EPO; JPO;	
			DERWENT;	
1			IBM TDB	<u> </u>

			PAT;	2003/02/13
	265	(174/2 .CCLS.	US-PGPUB;	15:06
			EPO; JPO;	13.00
			DERWENT;	
			IBM TDB	
		174.ccls.	USPAT;	2003/02/13
-	0	1/4.CCIS.	US-PGPUB;	15:05
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
	0	257.ccls.	USPAT;	2003/02/13
-		257.0013.	US-PGPUB;	15:05
			EPO; JPO;	,
		·	DERWENT;	
			IBM_TDB	
	1 0	257.ccls	USPAT;	2003/02/13
			US-PGPUB;	15:05
			EPO; JPO;	
	1		DERWENT;	
	1		IBM_TDB	2222 (22 (22
1 -	6	(transmission with lines same substrate	USPAT;	2003/02/13
		and impedance) and ((174/264).CCLS.)	US-PGPUB;	15:07
			EPO; JPO;	
•			DERWENT;	
			<pre>IBM_TDB USPAT;</pre>	2003/02/13
-	17	transmission with lines and	USPAI; US-PGPUB;	15:09
		((174/264).CCLS.)	EPO; JPO;	13.05
			DERWENT;	
		,	IBM TDB	
	11	(transmission with lines and	USPAT;	2003/02/13
_	11	((174/264).CCLS.)) not ((transmission	US-PGPUB;	15:09
	1	with lines same substrate and impedance)	EPO; JPO;	
1		and ((174/264).CCLS.))	DERWENT;	
			IBM_TDB	
_	5	("4494083" "4673904" "5012047"	USPAT	2003/02/13
		"5499005" "5644276").PN.		15:08
_	976	(174/262).CCLS.	USPAT;	2003/02/13
			US-PGPUB;	15:09
	-		EPO; JPO; DERWENT;] [
			IBM TDB	
		transmission with lines and	USPAT;	2003/02/13
-	61	((174/262).CCLS.)	US-PGPUB;	15:10
		((1/4/262).0015.)	EPO; JPO;	
			DERWENT;	<u> </u>
	1		IBM_TDB	
_	55	(transmission with lines and	USPAT;	2003/02/13
		((174/262).CCLS.)) not (transmission with	US-PGPUB;	15:13
		lines and ((174/264).CCLS.))	EPO; JPO;	
	1		DERWENT;	
			IBM_TDB	2003/02/13
-	4355	transmission and lines and substrate	EPO; JPO; DERWENT;	15:15
			IBM TDB	13.13
		(transmission and lines and substrate)	EPO; JPO;	2003/02/13
-	881		DERWENT;	15:13
	,	and ground	IBM TDB	
	15	((transmission and lines and substrate)	EPO; JPO;	2003/02/13
-	13	and ground) and diameter	DERWENT;	15:14
			IBM_TDB	
_	102	(transmission and lines and substrate)	EPO; JPO;	2003/02/13
	102	and diameter	DERWENT;	15:15
	1		IBM_TDB	
_	111925	transmission with lines	EPO; JPO;	2003/02/13
1			DERWENT;	15:15
			IBM_TDB	2002/02/12
-	1409	(transmission with lines) and diameter	EPO; JPO;	2003/02/13
			DERWENT;	15:16
1	1		IBM TDB	

	218	((trans sion with lines) and diameter)	; JPO;	2003/02/13
		and (instrating dielectric)	bankWENT;	15:16
		4	IBM_TDB	
_	34	4494083.URPN.	USPAT	2003/02/13
-				15:25
_	6	("2422160" "2938175" "4494083"	USPAT	2003/02/13
_		"4816791" "5093640" "5994983").PN.		15:28
_	7	("4276558" "4626805" "5057798"	USPAT	2003/02/13
_	1	"5229727" "5424693" "5428327"		15:34
		"5832598").PN.		
_	3	,	USPAT	2003/02/13
_		033130010112111		15:34
_	1	1993JP-0203378.ap,prai.	USPAT;	2003/02/15
_	1	199001 02000 011111111111111111111111111	US-PGPUB;	10:39
			EPO; JPO;	
	ļ		DERWENT;	
			IBM TDB	
_	1 1	JP-05203378-\$.did.	USPAT;	2003/02/15
_		01 00200000	US-PGPUB;	10:38
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	0	1992JP-013278.ap,prai.	USPAT;	2003/02/15
		1,1	US-PGPUB;	10:39
			EPO; JPO;	
			DERWENT;	ļ
			IBM_TDB	
_	1	1992JP-0013278.ap, prai.	USPAT;	2003/02/15
			US-PGPUB;	11:02
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	1	1993-291906.NRAN.	DERWENT	2003/02/15
				10:40
_	2	"6392164" .pn.	USPAT;	2003/02/15
			US-PGPUB;	15:05
			EPO; JPO;	
			DERWENT;	1
			IBM_TDB	